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| Substitute for form 1449/PTO                             |   |    |   | <i>Complete if Known</i> |                      |
| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b> |   |    |   | Application Number       | 10/601,191           |
| (use as many sheets as necessary)                        |   |    |   | Filing Date              | June 23, 2003        |
|  |   |    |   | First Named Inventor     | Seong-June Yi        |
|  |   |    |   | Art Unit                 | 2419                 |
|  |   |    |   | Examiner Name            | Michael J. Moore Jr. |
| Sheet  | 1 | of | 3 | Attorney Docket Number   |                      |
| 8737.046.00  |   |    |   |                          |                      |

## U.S. PATENT DOCUMENTS

|                               |  |                            |  |
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| <b>Examiner<br/>Signature</b> |  | <b>Date<br/>Considered</b> |  |
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| FOREIGN PATENT DOCUMENTS |                                 |   |                                |  |   |
|--------------------------|---------------------------------|---|--------------------------------|--|---|
| Examiner Initials*       | Cite No. <sup>1</sup>           | Foreign Patent Document   | Publication Date<br>MM-DD-YYYY | Name of Patentee or<br>Applicant of Cited Document | Pages, Columns, Lines,<br>Where Relevant Passages<br>or Relevant Figures Appear |
|                          |                                 | Country Code <sup>3</sup> -Number <sup>4</sup> -Kind Code <sup>5</sup> (if known) |                                |  |   |
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| BBP                      |                                 |   |                                |  |   |

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| <b>NON PATENT LITERATURE DOCUMENTS</b> |                       |   |  |  |  |                          |
|--|-----------------------|---|--|--|--|--------------------------|
| Examiner Initials <sup>*</sup>         | Cite No. <sup>1</sup> | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. |  |  |  | <sup>T<sup>2</sup></sup> |
|  | CA                    | "3 <sup>rd</sup> Generation Partnership Project : Technical Specification Group Services and System Aspects; Multimedia Broadcast/Multicast Service (MBMS); Architecture and Functional Description (Release 6), 3GPP TS 23.246 V6.1.0, December 2003           |  |  |  |                          |
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|  | CC                    |   |  |  |  |                          |

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. <sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kinds Codes of USPTO Patent Documents at [www.uspto.gov](http://www.uspto.gov) or MPEP 901.04. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the application number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached.

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